

DOCKET NO: 247830US20CONT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
QIN-YI TONG ET AL. : ATTN: APPLICATION DIVISION
SERIAL NO: NEW U.S. CONT APPLN. :
(Based on 09/505,283)
FILED: HERewith :
FOR: METHOD FOR LOW :
TEMPERATURE BONDING AND
BONDED STRUCTURE

PRELIMINARY AMENDMENT

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Prior to examination on the merits, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 6 of this paper.

Remarks/Arguments begin on page 9 of this paper.